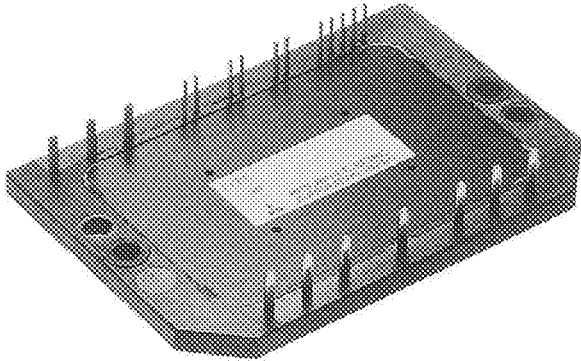


CM10MD-24H

MEDIUM POWER SWITCHING USE
INSULATED TYPE

CM10MD-24H



- IC 10A
- VCES 1200V
- Insulated Type
- CIB Module
- 3φ Inverter+3φ Converter+Brake
- UL Recognized

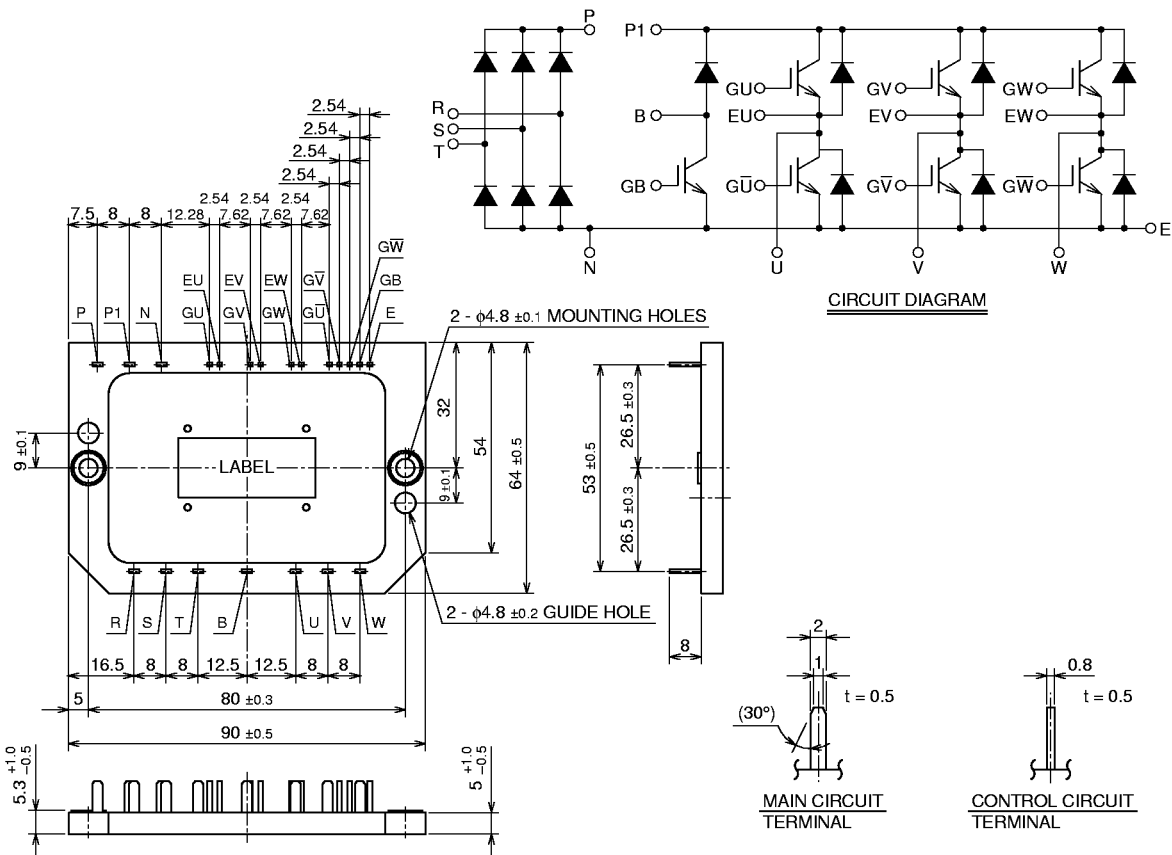
Yellow Card No. E80276 (N)
File No. E80271

APPLICATION

AC & DC motor controls, General purpose inverters, Servo controls, NC, Robotics

OUTLINE DRAWING & CIRCUIT DIAGRAM

Dimensions in mm



Note. Not use the guiding holes to mount on the cooling fin.

CM10MD-24H

MEDIUM POWER SWITCHING USE
INSULATED TYPE

MAXIMUM RATINGS (T_j = 25°C)

INVERTER PART

Symbol	Parameter	Condition	Rating	Unit
V _{CES}	Collector-emitter voltage	G – E Short	1200	V
V _{GES}	Gate-emitter voltage	C – E Short	±20	V
I _C	Collector Current	T _C = 25°C	10	A
I _{CM}		PULSE (Note. 2)	20	A
I _E (Note. 1)	Emitter Current	T _C = 25°C	10	A
I _{EM} (Note. 1)		PULSE (Note. 2)	20	A
P _C (Note. 3)	Maximum collector dissipation	T _f = 25°C	57	W

BRAKE PART

Symbol	Parameter	Condition	Rating	Unit
V _{CES}	Collector-emitter voltage	G – E Short	1200	V
V _{GES}	Gate-emitter voltage	C – E Short	±20	V
I _C	Collector Current	T _C = 25°C	10	A
I _{CM}		PULSE (Note. 2)	20	A
P _C (Note. 3)	Maximum Collector dissipation	T _f = 25°C	57	W
V _{RRM}	Repetitive peak reverse voltage	Clamp diode part	1200	V
I _{FM} (Note. 3)	Forward current	Clamp diode part	10	A

CONVERTER PART

Symbol	Parameter	Condition	Rating	Unit
V _{RRM}	Repetitive peak reverse voltage		1600	V
E _a	Recommended AC input voltage		440	V
I _o	DC output current	3φ rectifying circuit	10	A
I _{FSM}	Surge (non-repetitive) forward current	1 cycle at 60Hz, peak value Non-repetitive	100	A
I ² t	I ² t for fusing	Value for one cycle of surge current	42	A ² s

COMMON RATING

Symbol	Parameter	Condition	Rating	Unit
T _j	Junction temperature		-40 ~ +150	°C
T _{stg}	Storage temperature		-40 ~ +125	°C
V _{iso}	Isolation voltage	AC 1 min.	2500	V
—	Mounting torque	Mounting M4 screw	1.47 ~ 1.96	N · m
—	Weight	Typical value	60	g

CM10MD-24H

MEDIUM POWER SWITCHING USE
INSULATED TYPE

ELECTRICAL CHARACTERISTICS (T_J = 25°C) INVERTER PART

Symbol	Parameter	Test conditions	Limits			Unit	
			Min.	Typ.	Max.		
ICES	Collector cutoff current	VCE = VCES, VGE = 0V	—	—	1	mA	
VGE(th)	Gate-emitter threshold voltage	IC = 1.0mA, VCE = 10V	4.5	6	7.5	V	
IGES	Gate-emitter cutoff current	VGE = VGES, VCE = 0V	—	—	0.5	μA	
VCE(sat)	Collector-emitter saturation voltage	IC = 10A, VGE = 15V (Note. 4)	T _J = 25°C	—	2.7	3.4	V
			T _J = 150°C	—	2.45	—	
Cies	Input capacitance	VCE = 10V VGE = 0V	—	—	2.0	nF	
Coes	Output capacitance		—	—	1.5	nF	
Cres	Reverse transfer capacitance		—	—	0.4	nF	
QG	Total gate charge	VCC = 600V, IC = 10A, VGE = 15V	—	50	—	nC	
td (on)	Turn-on delay time	VCC = 600V, IC = 10A	—	—	100	ns	
tr	Turn-on rise time	VGE1 = VGE2 = 15V	—	—	200	ns	
td (off)	Turn-off delay time	RG = 31Ω	—	—	150	ns	
tf	Turn-off fall time	Resistive load	—	—	350	ns	
VEC (Note. 1)	Emitter-collector voltage	IE = 10A, VGE = 0V	—	—	3.5	V	
trr (Note. 1)	Reverse recovery time	IE = 10A, VGE = 0V	—	—	250	ns	
Qrr (Note. 1)	Reverse recovery charge	die / dt = - 20A / μs	—	0.08	—	μC	
Rth(j-Q) (Note. 5)	Thermal resistance	IGBT part, Per 1/6 module	—	—	2.2	°C/W	
Rth(j-R) (Note. 5)		FWDi part, Per 1/6 module	—	—	3.1	°C/W	

BRAKE PART

Symbol	Parameter	Condition	Limits			Unit	
			Min.	Typ.	Max.		
ICES	Collector cutoff current	VCE = VCES, VGE = 0V	—	—	1	mA	
VGE(th)	Gate-emitter threshold voltage	IC = 1.0mA, VCE = 10V	4.5	6	7.5	V	
IGES	Gate-emitter cutoff current	VGE = VGES, VCE = 0V	—	—	0.5	μA	
VCE(sat)	Collector-to-emitter saturation voltage	IC = 10A, VGE = 15V (Note. 4)	T _J = 25°C	—	2.7	3.4	V
			T _J = 150°C	—	2.45	—	
Cies	Input capacitance	VCE = 10V VGE = 0V	—	—	2.0	nF	
Coes	Output capacitance		—	—	1.5	nF	
Cres	Reverse transfer capacitance		—	—	0.4	nF	
QG	Total gate charge	VCC = 600V, IC = 10A, VGE = 15V	—	50	—	nC	
VFM	Forward voltage drop	IF = 10A, Clamp diode part	—	—	1.7	V	
Rth(j-Q) (Note. 5)	Thermal resistance	IGBT part	—	—	2.2	°C/W	
Rth(j-R) (Note. 5)		Clamp diode part	—	—	2.7	°C/W	

CONVERTER PART

Symbol	Parameter	Condition	Limits			Unit
			Min.	Typ.	Max.	
IRRM	Repetitive reverse current	VR = VRRM, T _J = 150°C	—	—	8	mA
VFM	Forward voltage drop	IF = 10A	—	—	1.7	V
Rth(j-Q) (Note. 5)	Thermal resistance	Per 1/6 module	—	—	2.7	°C/W

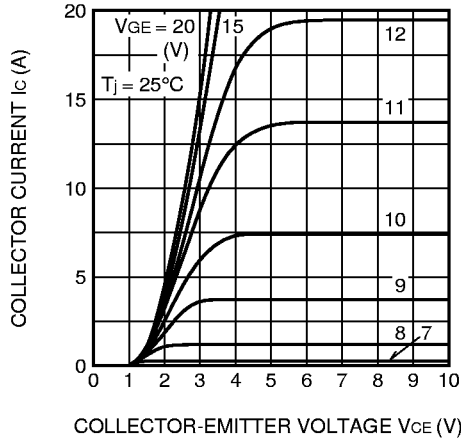
- Note 1. IE, VEC, trr, Qrr & die/dt represent characteristics of the anti-parallel, emitter to collector free-wheel diode.
 2. Pulse width and repetition rate should be such that the device junction temp. (T_J) does not exceed T_{Jmax} rating.
 3. Junction temperature (T_J) should not increase beyond 150°C.
 4. Pulse width and repetition rate should be such as to cause negligible temperature rise.
 5. Thermal resistance is specified under following conditions.
 • The conductive grease applied, between module and fin.
 • Al plate is used as fin.

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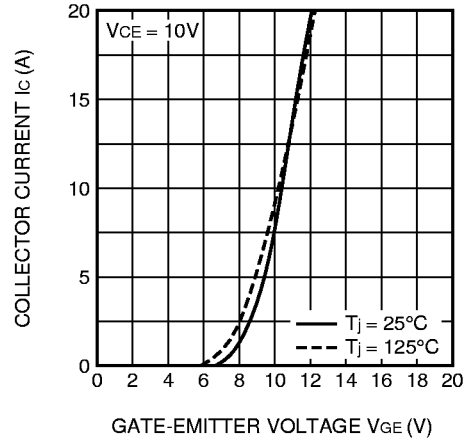
MEDIUM POWER SWITCHING USE
INSULATED TYPE

PERFORMANCE CURVES

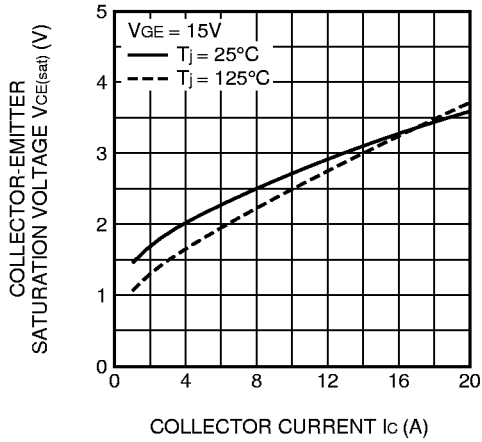
OUTPUT CHARACTERISTICS (TYPICAL)



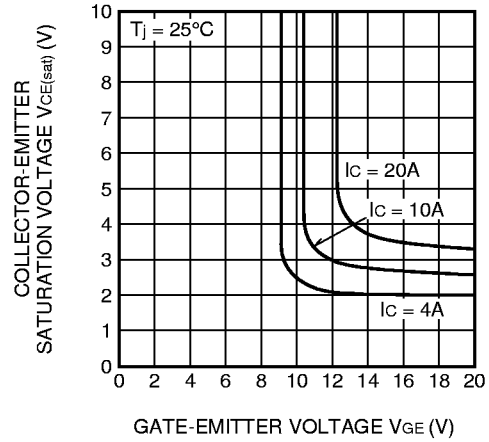
TRANSFER CHARACTERISTICS (TYPICAL)



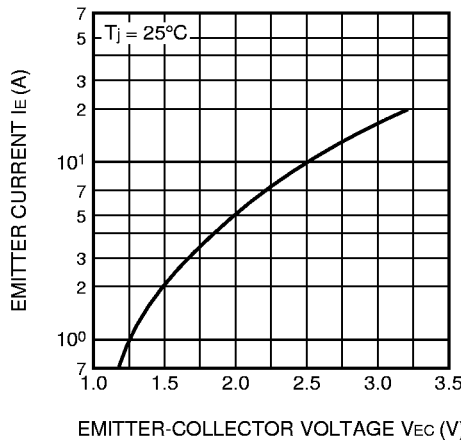
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



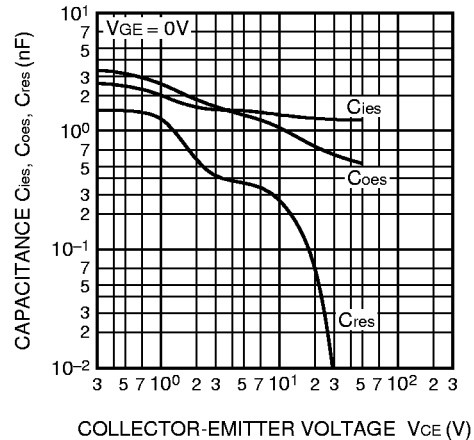
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



FREE-WHEEL DIODE FORWARD CHARACTERISTICS (TYPICAL)



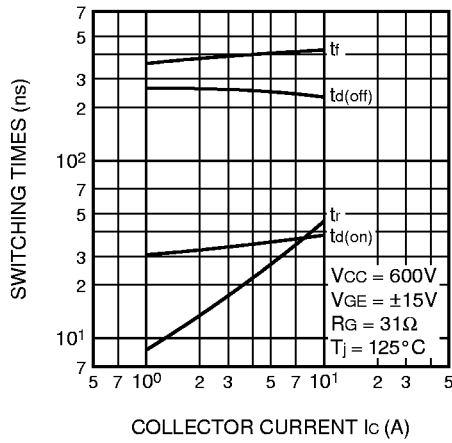
CAPACITANCE VS. Vce (TYPICAL)



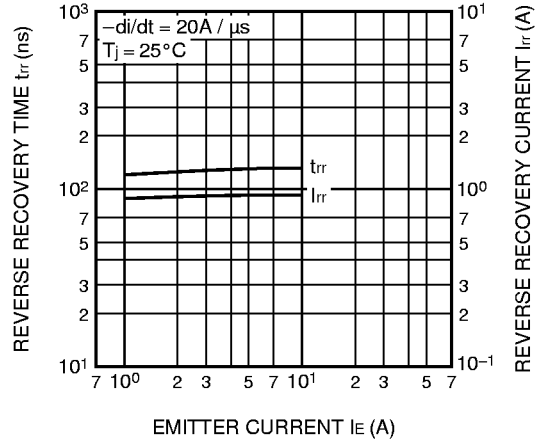
CM10MD-24H

MEDIUM POWER SWITCHING USE
INSULATED TYPE

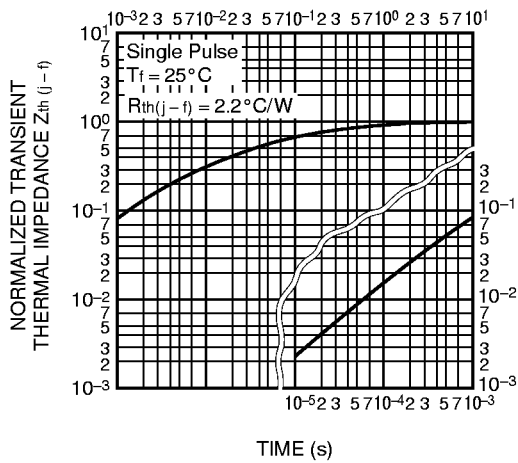
**HALF-BRIDGE
SWITCHING CHARACTERISTICS
(TYPICAL)**



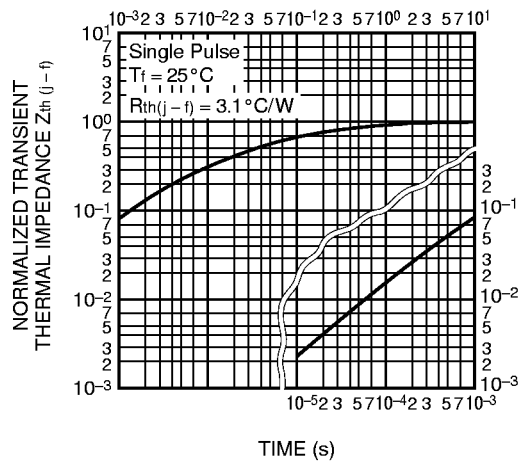
**REVERSE RECOVERY CHARACTERISTICS
OF FREE-WHEEL DIODE
(TYPICAL)**



**TRANSIENT THERMAL
IMPEDANCE CHARACTERISTICS
(IGBT part)**



**TRANSIENT THERMAL
IMPEDANCE CHARACTERISTICS
(FWDi part)**



**VGE - GATE CHARGE
(TYPICAL)**

